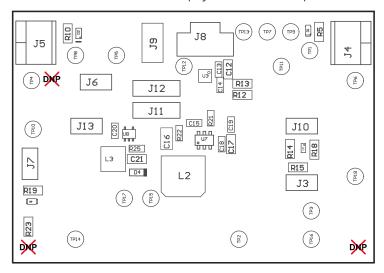
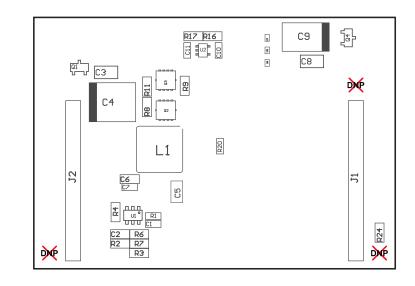
- ZZI ■Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.
- ZZ2 These assemblies are ESD sensitive, ESD precautions shall be observed.
- ZZ3 These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- ZZ4 These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



## COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-01586	REV: E1	SUN REU: Not	In VersionControl
	TID #: TIDA-01586 Board 2			
PLOT NAME = Top Assembly Drawing	GENERATED : 2/2/20	1:05:13	PM 1	TEXAS INSTRUMENTS



## COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-01586 REV: E1	SVN REV: Not In VersionControl		
	TID #: TIDA-01586 Board 2			
PLOT NAME = Bottom Assembly Drawing	GENERATED : 2/2/2018 1:05:	14 PM TEXAS INSTRUMENTS		

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